

**FEATURES**

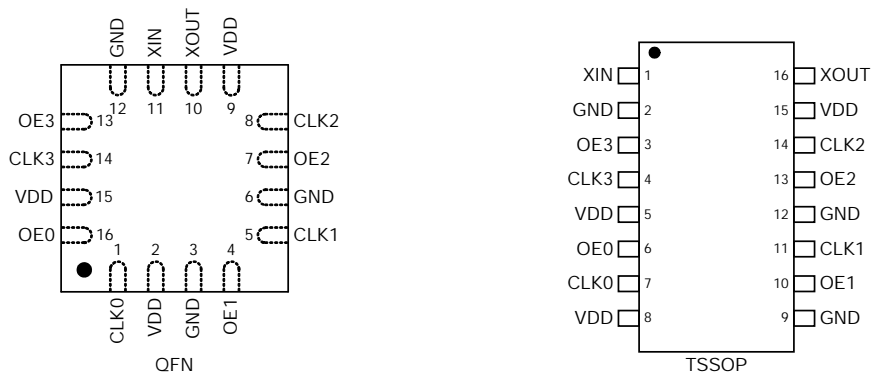
- Advanced Oscillator Design for Wide Frequency Coverage
- 4 LVCMOS Outputs with Individual OE Control
- 8mA Output Drive Strength
- Input/Output Frequency:
  - Fundamental Crystal: 10MHz to 40MHz
- Very Low Jitter and Phase Noise
- Low Current Consumption
- Single 1.62V to 3.63V Power Supply
- Available in QFN-16L and TSSOP-16L GREEN/RoHS Compliant Packages

**DESCRIPTION**

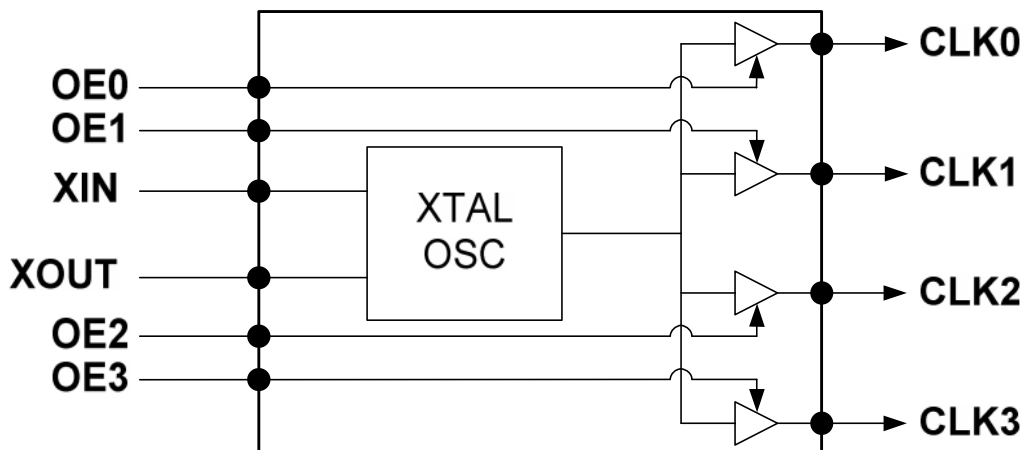
The SVD215-47 is an advanced oscillator fanout buffer design for high performance, low-power, small form-factor applications. The SVD215-47 accepts a fundamental input crystal of 10MHz to 40MHz and produces four outputs of the same frequency, each with its own Output Enable pin.

Offered in a small 3 x 3mm QFN or TSSOP package, the SVD215-47 offers the best phase noise and jitter performance and lowest power consumption of any comparable IC.

**PACKAGE PIN CONFIGURATION**



**BLOCK DIAGRAM**



**PACKAGE PIN ASSIGNMENT**

Name	Package Pin #		Type	Description
	QFN-16L	(T)SSOP-16L		
CLK0	1	7	O	Output clock
VDD	2, 9, 15	5, 8, 15	P	V <sub>DD</sub> connection
GND	3, 6, 12	2, 9, 12	P	GND connection
OE1	4	10	I*	Output enable (OE) input for CLK1. Internal pull-up. Pull low to tri-state CLK1.
CLK1	5	11	O	Output clock
OE2	7	13	I*	Output enable (OE) input for CLK2. Internal pull-up. Pull low to tri-state CLK2.
CLK2	8	14	O	Output clock
XOUT	10	16	O	Crystal output. Do not connect when using a reference clock.
XIN	11	1	I	Crystal input
OE3	13	3	I*	Output enable (OE) input for CLK3. Internal pull-up. Pull low to tri-state CLK3.
CLK3	14	4	O	Output clock
OE0	16	6	I*	Output enable (OE) input for CLK0. Internal pull-up. Pull low to tri-state CLK0.

\* Note: These pins include an internal 60K pull up.

## LAYOUT RECOMMENDATIONS

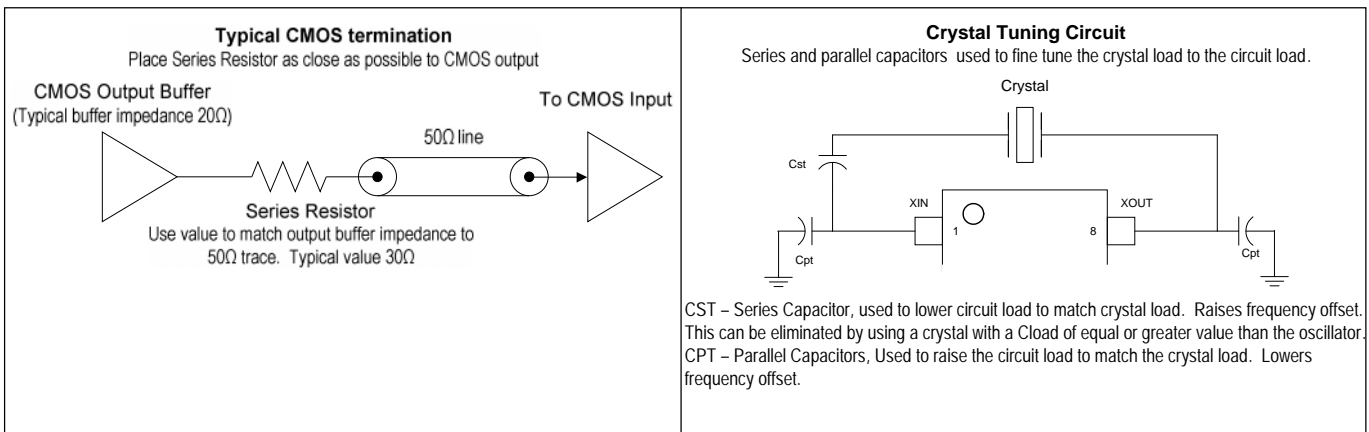
The following guidelines are to assist you with a performance optimized PCB design:

### Signal Integrity and Termination Considerations

- Keep traces short!
- Trace = Inductor. With a capacitive load this equals ringing!
- Long trace = Transmission Line. Without proper termination this will cause reflections (looks like ringing).
- Design long traces as "striplines" or "microstrips" with defined impedance.
- Match trace at one side to avoid reflections bouncing back and forth.

### Decoupling and Power Supply Considerations

- Place decoupling capacitors as close as possible to the  $V_{DD}$  pin(s) to limit noise from the power supply
- Multiple  $V_{DD}$  pins should be decoupled separately for best performance.
- Addition of a ferrite bead in series with  $V_{DD}$  can help prevent noise from other board sources
- Value of decoupling capacitor is frequency dependant. Typical value to use is  $0.1\mu F$ .



## ELECTRICAL SPECIFICATIONS

### ABSOLUTE MAXIMUM RATINGS

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage Range	$V_{DD}$	-0.5	4.6	V
Input Voltage Range	$V_I$	-0.5	$V_{DD}+0.5$	V
Output Voltage Range	$V_O$	-0.5	$V_{DD}+0.5$	V
Storage Temperature	$T_S$	-65	150	$^{\circ}C$
Ambient Operating Temperature*		-40	85	$^{\circ}C$

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied. \*Operating temperature is guaranteed by design. Parts are tested to commercial grade only.

**AC SPECIFICATIONS**

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Crystal Input Frequency	Fundamental crystal	10		40	MHz
Settling Time	At power-up ( $V_{DD} \geq 1.62V$ )			2	ms
Output Enable Time	OE Function; $T_a=25^\circ C$			10	ns
$V_{DD}$ Sensitivity	Frequency vs. $V_{DD}$ , $\pm 10\%$	-2		2	ppm
Output Rise Time	15pF Load, 10/90% $V_{DD}$ , 3.3V		2	4	ns
Output Fall Time	15pF Load, 90/10% $V_{DD}$ , 3.3V		2	4	ns
Output to Output Skew	Under all conditions			1	ns
Duty Cycle	Under all conditions	45	50	55	%

**DC SPECIFICATIONS**

PARAMETERS	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Current, Dynamic	$I_{DD}$	$V_{DD} = 3.3V$ , 25MHz, No Load		6.5		mA
		$V_{DD} = 2.5V$ , 25MHz, No Load		4.4		mA
		$V_{DD} = 1.8V$ , 25MHz, No Load		3.2		mA
Operating Voltage	$V_{DD}$		1.62		3.63	V
Output Low Voltage	$V_{OL}$	$I_{OL} = +4mA$ , 3.3V			0.4	V
Output High Voltage	$V_{OH}$	$I_{OH} = -4mA$ , 3.3V	2.4			V
Output Current	$I_{OSD}$	$V_{OL} = 0.4V$ , $V_{OH} = 2.4V$	8			mA

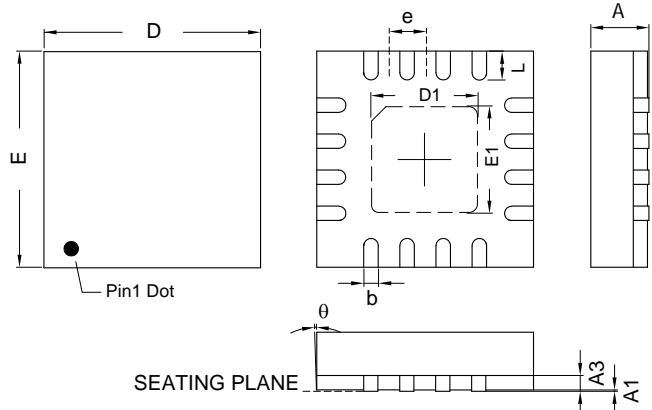
**CRYSTAL SPECIFICATIONS**

PARAMETERS		SYMBOL	MIN.	TYP.	MAX.	UNITS
Fundamental Crystal Resonator Frequency		$F_{XIN}$	10		40	MHz
Crystal Loading Rating		$C_L (xtal)$		15		pF
Operating Drive Level				0.1	2	mW
Metal Can Crystal	Shunt Capacitance	$C_0$			5.5	pF
	ESR Max	ESR			40	
Small SMD Crystal	Shunt Capacitance	$C_0$			2.5	pF
	ESR Max	ESR			60	

**PACKAGE DRAWINGS (GREEN PACKAGE COMPLIANT)**

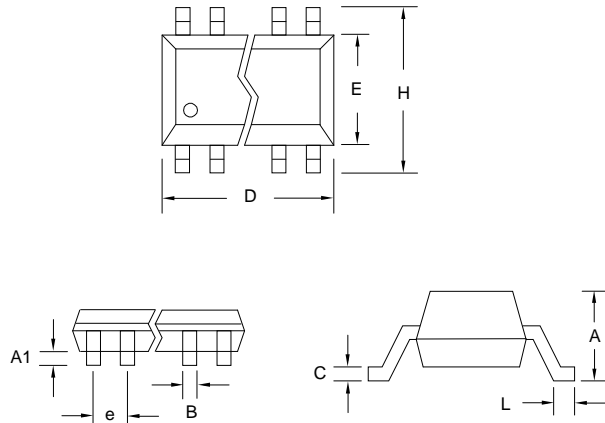
**QFN 16L**

Symbol	Dimension in MM	
	Min.	Max.
A	0.07	0.8
A1	0.05	0.05
A3	0.20	
b	0.18	0.30
D	3.00 BSC	
E	3.00 BSC	
D1	--	1.70
E1	--	1.70
L	0.30	0.50
e	0.50 BSC	

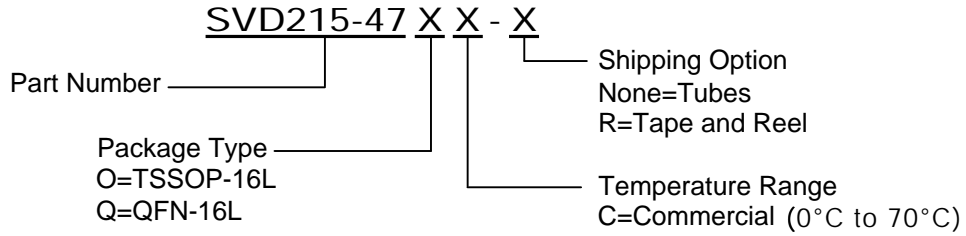


**TSSOP 16L**

Symbol	Dimension in MM	
	Min.	Max.
A	-	1.20
A1	0.05	0.15
b	0.19	0.30
C	0.09	0.20
D	4.90	5.10
E	4.30	4.50
H	6.20	6.60
L	0.45	0.75
e	0.635 BSC	



**ORDERING INFORMATION (GREEN PACKAGE COMPLIANT)**



Part Number/Order Number	Marking	Package Option
SVD215-47OC	SVD215-47 OC	16-Pin TSSOP (Tube)
SVD215-47OC-R	LLLLL	16-Pin TSSOP (Tape and Reel)
SVD215-47QC-R	SVD215 -47 LLL	16-Pin QFN (Tape and Reel)

\*Note: "LLL" or "LLLLL" designates lot number